

Law Offices
ARMSTRONG, WESTERMAN, & HATTORI, LLP
Suite 1000, 1725 K Street
Washington, D.C. 20006

(202) 659-2930
Facsimile (202) 887-0357 or (202) 331-7519

FACSIMILE TRANSMISSION COVER SHEET

DATE: February 20, 2002

TO: Examiner C. Chu
U.S. Patent and Trademark Office
Group Art Unit: 2815

Re: **Supplemental Amendment**
U.S. Patent Application Serial No.: 09/577,932
Our Reference: 000663

FROM: Michael N. Lau

FAC.. TEL. NO.: 703-746-3865

NUMBER OF PAGES (INCLUDING THIS COVER SHEET): 6

PLEASE ACKNOWLEDGE SAFE AND CLEAR RECEIPT OF ALL PAGES BEING SENT

MNL/led

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Shigeyuki MARUYAMA, et al.

Serial Number: 09/577,932

Group Art Unit: 2815

Filed: May 25, 2000

Examiner: C. Chu

For: **SEMICONDUCTOR DEVICE HAVING AN ALIGNMENT MARK FORMED BY
THE SAME MATERIAL WITH A METAL POST**

9
Suppl
Amend B
F Jones
2-22-02

SUPPLEMENTAL AMENDMENT UNDER 37 CFR §1.111

Commissioner for Patents
Washington, D.C. 20231

February 20, 2002

Sir:

Further to the Amendment filed Under 37 CFR §1.111 on December 5, 2001, this is a Supplemental Amendment filed in response to the Office Action dated September 21, 2001, please amend the above-identified application as follows:

IN THE CLAIMS:

For the convenience of the Office, all pending claims are listed as shown hereinbelow.

Please amend the claims as follows:

1. (Twice Amended) A semiconductor device comprising:
- a semiconductor element having a plurality of electrodes;
 - a redistribution layer having a plurality of electrode pads and conductive patterns connecting the electrodes of the semiconductor element to the respective electrode pads;

B1
Rubin